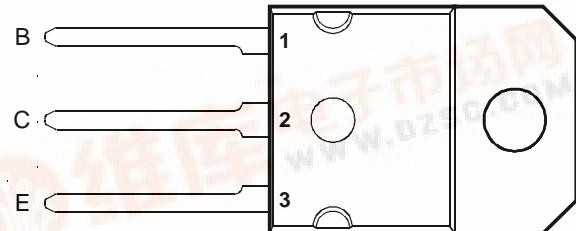


- Designed for Complementary Use with BDW84, BDW84A, BDW84B, BDW84C and BDW84D
- 150 W at 25°C Case Temperature
- 15 A Continuous Collector Current
- Minimum  $h_{FE}$  of 750 at 3 V, 6 A

**SOT-93 PACKAGE  
(TOP VIEW)**

Pin 2 is in electrical contact with the mounting base.

MDTRAA

**absolute maximum ratings at 25°C case temperature (unless otherwise noted)**

RATING	SYMBOL	VALUE	UNIT
Collector-base voltage ( $I_E = 0$ )	$V_{CBO}$	BDW83	45
		BDW83A	60
		BDW83B	80
		BDW83C	100
		BDW83D	120
Collector-emitter voltage ( $I_B = 0$ ) (see Note 1)	$V_{CEO}$	BDW83	45
		BDW83A	60
		BDW83B	80
		BDW83C	100
		BDW83D	120
Emitter-base voltage	$V_{EBO}$	5	V
Continuous collector current	$I_C$	15	A
Continuous base current	$I_B$	0.5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)	$P_{tot}$	150	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)	$P_{tot}$	3.5	W
Unclamped inductive load energy (see Note 4)	$\frac{1}{2}LI_C^2$	100	mJ
Operating junction temperature range	$T_j$	-65 to +150	°C
Operating temperature range	$T_{stg}$	-65 to +150	°C
Operating free-air temperature range	$T_A$	-65 to +150	°C

NOTES: 1. These values apply when the base-emitter diode is open circuited.

2. Derate linearly to 150°C case temperature at the rate of 1.2 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of:  $L = 20 \text{ mH}$ ,  $I_{B(on)} = 5 \text{ mA}$ ,  $R_{BE} = 100 \Omega$ ,  $V_{BE(off)} = 0$ ,  $R_S = 0.1 \Omega$ ,  $V_{CC} = 20 \text{ V}$ .

# BDW83, BDW83A, BDW83B, BDW83C, BDW83D NPN SILICON POWER DARLINGTONS

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## electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$	(see Note 5)	BDW83 BDW83A BDW83B BDW83C BDW83D	45 60 80 100 120		
$I_{CEO}$	Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$	$I_B = 0$		BDW83		1	
		$V_{CE} = 30 \text{ V}$	$I_B = 0$		BDW83A		1	
		$V_{CE} = 40 \text{ V}$	$I_B = 0$		BDW83B		1	
		$V_{CE} = 50 \text{ V}$	$I_B = 0$		BDW83C		1	
		$V_{CE} = 60 \text{ V}$	$I_B = 0$		BDW83D		1	
$I_{CBO}$	Collector cut-off current	$V_{CB} = 45 \text{ V}$	$I_E = 0$		BDW83		0.5	
		$V_{CB} = 60 \text{ V}$	$I_E = 0$		BDW83A		0.5	
		$V_{CB} = 80 \text{ V}$	$I_E = 0$		BDW83B		0.5	
		$V_{CB} = 100 \text{ V}$	$I_E = 0$		BDW83C		0.5	
		$V_{CB} = 120 \text{ V}$	$I_E = 0$		BDW83D		0.5	
		$V_{CB} = 45 \text{ V}$	$I_E = 0$	$T_C = 150^\circ\text{C}$	BDW83		5	
		$V_{CB} = 60 \text{ V}$	$I_E = 0$	$T_C = 150^\circ\text{C}$	BDW83A		5	
		$V_{CB} = 80 \text{ V}$	$I_E = 0$	$T_C = 150^\circ\text{C}$	BDW83B		5	
		$V_{CB} = 100 \text{ V}$	$I_E = 0$	$T_C = 150^\circ\text{C}$	BDW83C		5	
		$V_{CB} = 120 \text{ V}$	$I_E = 0$	$T_C = 150^\circ\text{C}$	BDW83D		5	
$I_{EBO}$	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				2	mA
$h_{FE}$	Forward current transfer ratio	$V_{CE} = 3 \text{ V}$	$I_C = 6 \text{ A}$	(see Notes 5 and 6)	750		20000	
		$V_{CE} = 3 \text{ V}$	$I_C = 15 \text{ A}$		100			
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = 3 \text{ V}$	$I_C = 6 \text{ A}$	(see Notes 5 and 6)			2.5	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 12 \text{ mA}$	$I_C = 6 \text{ A}$	(see Notes 5 and 6)			2.5	V
		$I_B = 150 \text{ mA}$	$I_C = 15 \text{ A}$				4	
$V_{EC}$	Parallel diode forward voltage	$I_E = 15 \text{ A}$	$I_B = 0$				3.5	V

NOTES: 5. These parameters must be measured using pulse techniques,  $t_p = 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

## thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			0.83	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			35.7	°C/W

## resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS <sup>†</sup>			MIN	TYP	MAX	UNIT
$t_{on}$	Turn-on time	$I_C = 10 \text{ A}$	$I_{B(on)} = 40 \text{ mA}$	$I_{B(off)} = -40 \text{ mA}$		0.9		μs
$t_{off}$	Turn-off time	$V_{BE(off)} = -4.2 \text{ V}$	$R_L = 3 \Omega$	$t_p = 20 \mu\text{s}$ , dc $\leq 2\%$		7		μs

<sup>†</sup> Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

# BDW83, BDW83A, BDW83B, BDW83C, BDW83D NPN SILICON POWER DARLINGTONS

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## TYPICAL CHARACTERISTICS

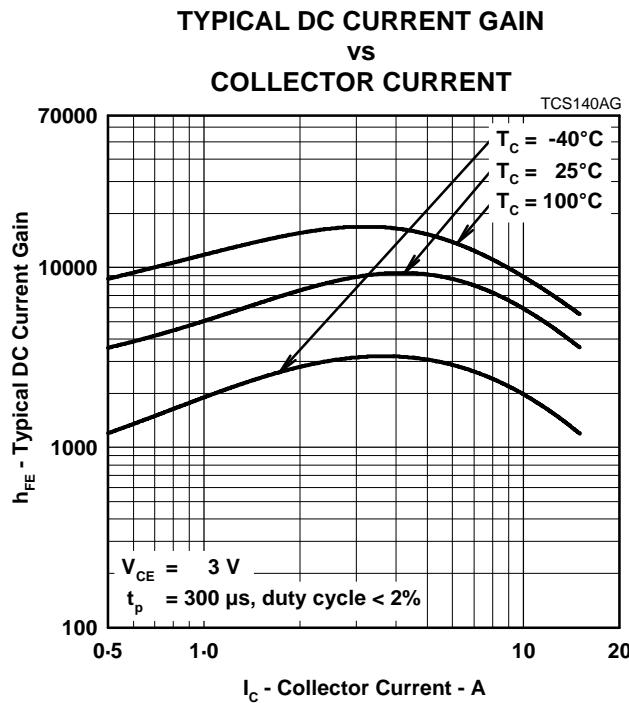


Figure 1.

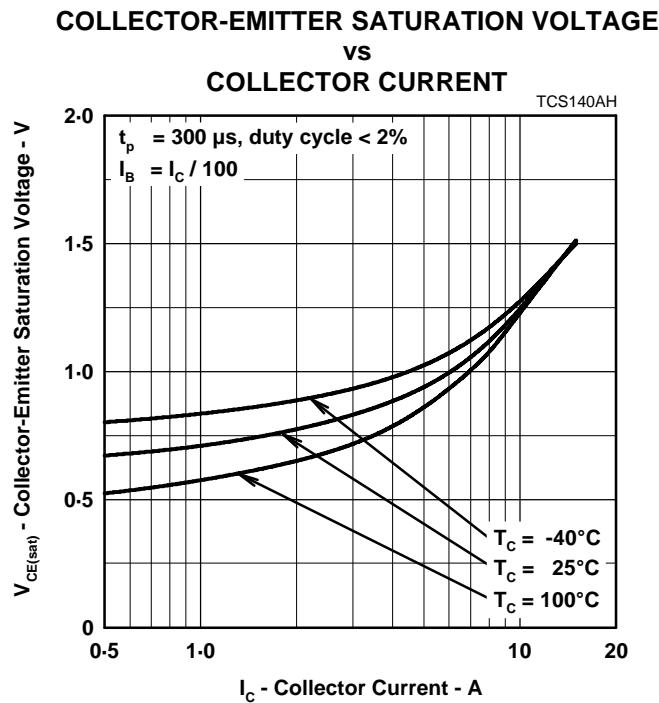


Figure 2.

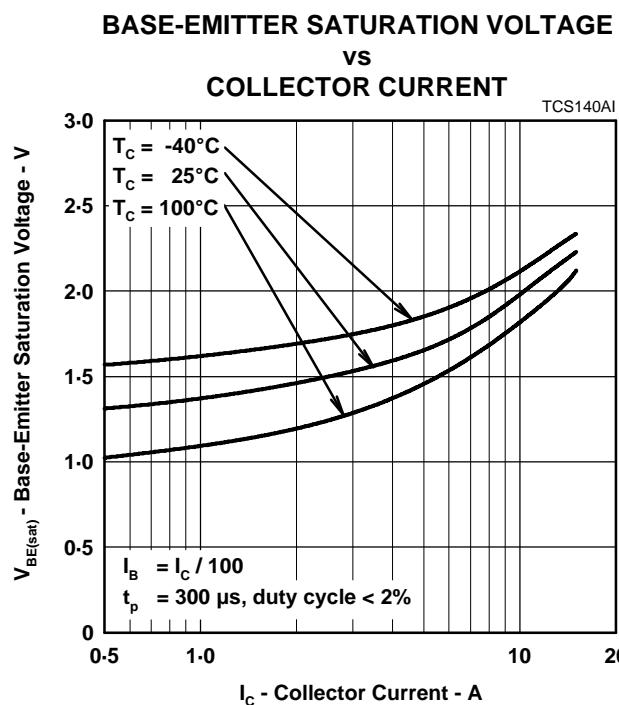


Figure 3.

# BDW83, BDW83A, BDW83B, BDW83C, BDW83D NPN SILICON POWER DARLINGTONS

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## MAXIMUM SAFE OPERATING REGIONS

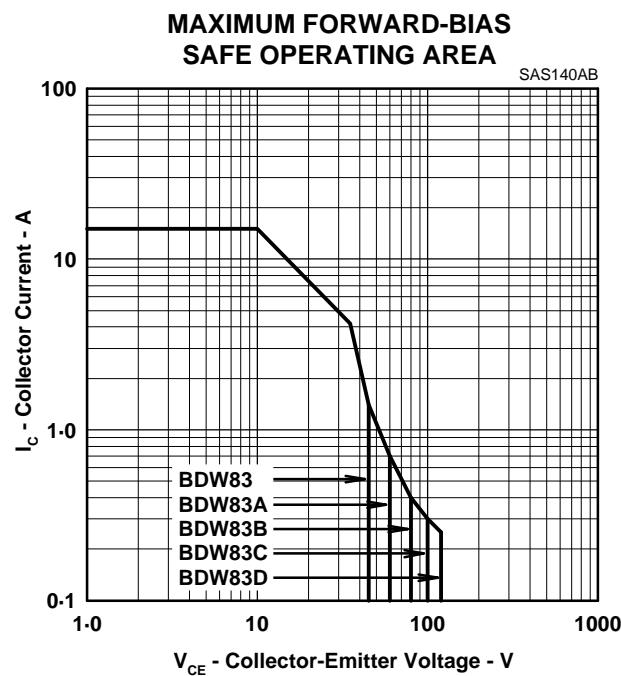


Figure 4.

## THERMAL INFORMATION

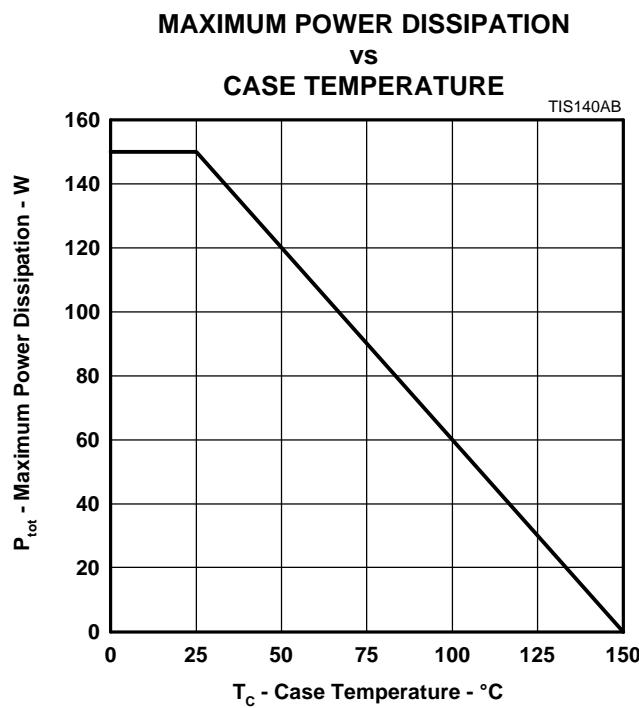


Figure 5.

# BDW83, BDW83A, BDW83B, BDW83C, BDW83D NPN SILICON POWER DARLINGTONS

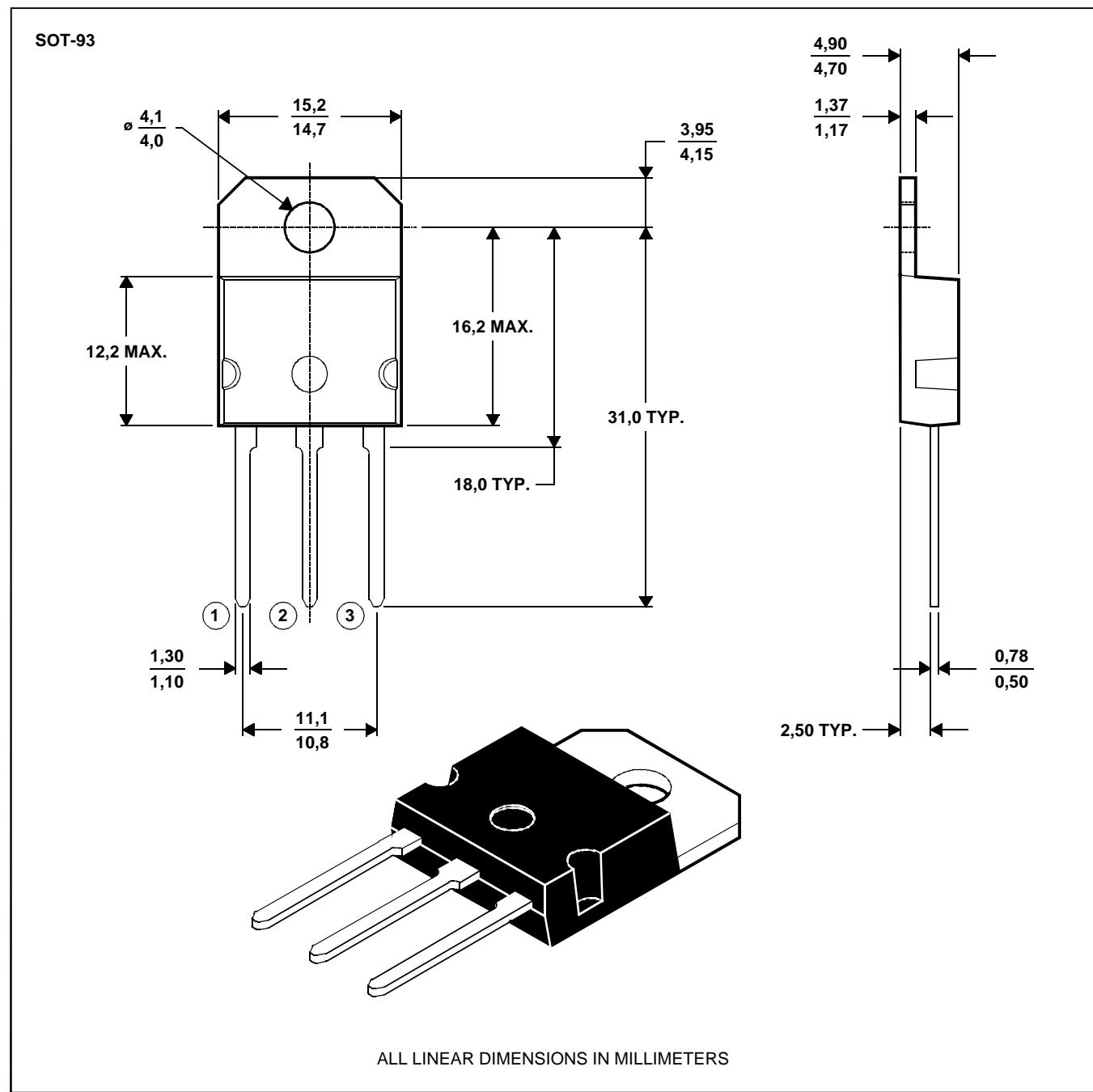
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## MECHANICAL DATA

### SOT-93

#### 3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTE A: The centre pin is in electrical contact with the mounting tab.

MDXXAW

# **BDW83, BDW83A, BDW83B, BDW83C, BDW83D**

## **NPN SILICON POWER DARLINGTONS**

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